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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET

MOS FIELD EFFECT TRANSISTOR μ**PA2790G**R

SWITCHING N- AND P-CHANNEL POWER MOS FET

DESCRIPTION

PACKAGE DRAWING (Unit: mm)

1 : Source 1

2

4

4.0

Gate 1

: Source 2 : Gate 2

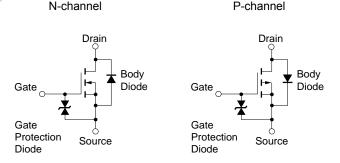
-1.0

□ 0.10

7, 8: Drain 1

5, 6: Drain 2

The µ PA2790GR is N- and P-channel MOS Field Effect N-channel Transistors designed for Motor Drive application. **FEATURES** P-channel 3 Low on-state resistance N-channel $R_{DS(on)1} = 28 \text{ m}\Omega \text{ MAX}$. (Vgs = 10 V, Ip = 3 A) 6.0 ±0.3 П $R_{DS(on)2} = 40 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 3 \text{ A})$ 5.37 Max .8 Max +0.05 P-channel R_{DS(on)1} = 60 m Ω MAX. (V_{GS} = -10 V, I_D = -3 A) 2 $R_{DS(on)2} = 80 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.5 \text{ V}, \text{ ID} = -3 \text{ A})$ +0.5 ±0.2 0.6 1.27 • Low input capacitance 0.40^{+0.11} 0.12 M N-channel Ciss = 500 pF TYP. P-channel Ciss = 460 pF TYP. **EQUIVALENT CIRCUITS** · Built-in gate protection diode



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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The mark <R> shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA2790GR	Power SOP8

Small and surface mount package (Power SOP8)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C. All terminals are connected.)

PARAMETER	SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain to Source Voltage (V _{GS} = 0 V)	VDSS	30	-30	V
Gate to Source Voltage (V _{DS} = 0 V)	Vgss	±20	∓20	V
Drain Current (DC)	ID(DC)	±6	∓6	А
Drain Current (pulse) Note1	I _{D(pulse)}	±24	∓24	А
Total Power Dissipation (1 unit) Note2	Рт	1.7		W
Total Power Dissipation (2 units) Note2	Рт	2.0		W
Channel Temperature	Tch	150		°C
Storage Temperature	Tstg	–55 to +150		°C
Single Avalanche Current Note3	las	6	-6	А
Single Avalanche Energy Note3	Eas	3.6	3.6	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Mounted on ceramic substrate of 2000 $\mbox{mm}^2 \mbox{ x 1.6 mm}$

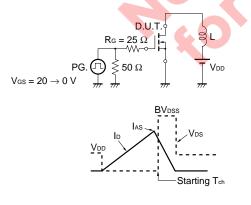
3. Starting T_{ch} = 25°C, V_{DD} = $\frac{1}{2}$ x V_{DSS}, R_G = 25 Ω, L = 100 µH, V_{GS} = V_{GSS} \rightarrow 0 V

ELECTRICAL CHARACTERISTICS (TA = 25°C. All terminals are connected.)

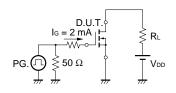
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	V _{DS} = 30 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = 10 V, I _D = 3 A	2			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = 10 V, I _D = 3 A		21	28	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 3 A		28	40	mΩ
	RDS(on)3	V _{GS} = 4.0 V, I _D = 3 A		34	53	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		500		pF
Output Capacitance	Coss	V _{GS} = 0 V		135		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		77		pF
Turn-on Delay Time	td(on)	VDD = 15 V, ID = 3 A		9.2		ns
Rise Time	tr	V _{GS} = 10 V		8.8		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		28		ns
Fall Time	tr			7.4		ns
Total Gate Charge	QG	ID = 6 A		12.6		nC
Gate to Source Charge	QGS	V _{DD} = 24 V		1.7		nC
Gate to Drain Charge	Qgd	V _{GS} = 10 V		3.8		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 6 A, Vgs = 0 V		0.85		V
Reverse Recovery Time	trr	IF = 6 A, VGS = 0 V		18		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		11		nC

Note Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY



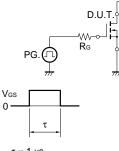
TEST CIRCUIT 3 GATE CHARGE



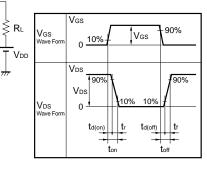
TEST CIRCUIT 2 SWITCHING TIME

Т

୷



 $\tau = 1 \,\mu s$ Duty Cycle $\leq 1\%$



NEC

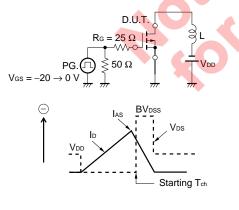
P-channel

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ibss	V _{DS} = -30 V, V _{GS} = 0 V			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 16 \text{ V}, V_{DS} = 0 \text{ V}$			∓10	μA
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-1.0		-2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = -10 V, I _D = -3 A	2			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = -10 V, I _D = -3 A		43	60	mΩ
	RDS(on)2	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$		58	80	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ I}_{D} = -3 \text{ A}$		65	110	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		460		pF
Output Capacitance	Coss	V _{GS} = 0 V		130		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		77		pF
Turn-on Delay Time	td(on)	VDD = -15 V, ID = -3 A		8.5		ns
Rise Time	tr	V _{GS} = -10 V		4.8		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		42		ns
Fall Time	tr			19		ns
Total Gate Charge	QG	ID = -6 A		11		nC
Gate to Source Charge	QGS	V _{DD} = -24 V		1.7		nC
Gate to Drain Charge	Qgd	V _{GS} = -10 V		3.3		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 6 A, VGS = 0 V		0.92		V
Reverse Recovery Time	trr	IF = 6 A, Vgs = 0 V		21		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		12		nC

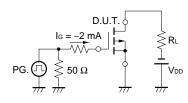
Note Pulsed

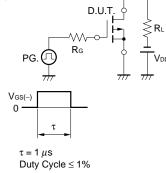
TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE

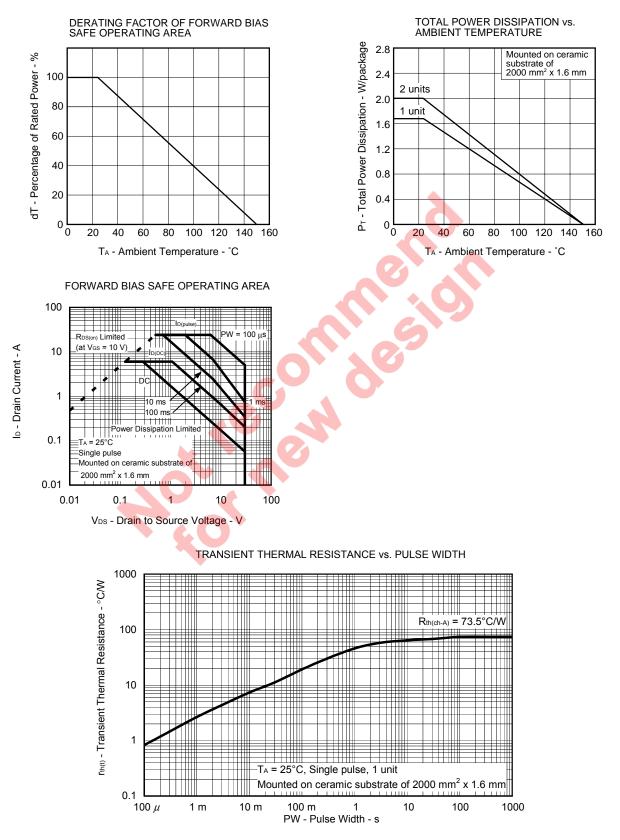




VGS Wave Form	VGS(-) 0 <u>10% -</u>	Vgs	90%
V _{DS} Wave Form	VDS(-) VDS 0 td(on)	ton	90%

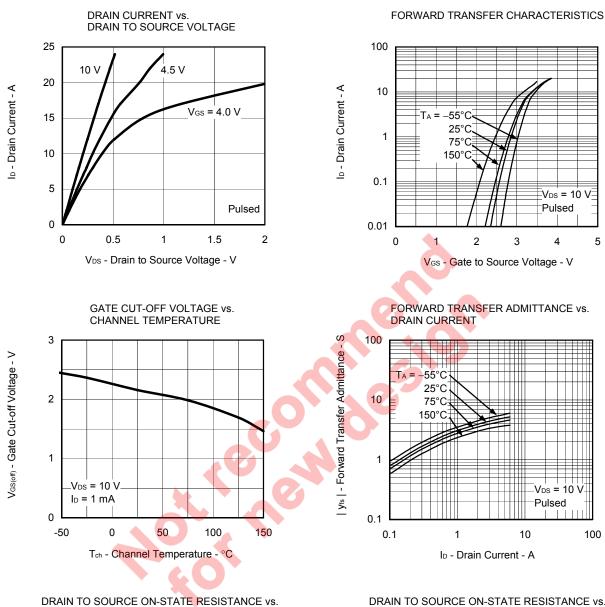
TYPICAL CHARACTERISTICS (TA = 25°C)

(1) N-channel

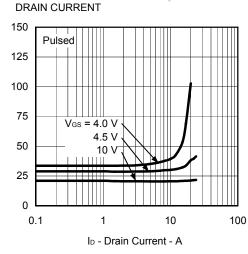


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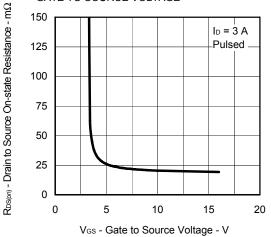
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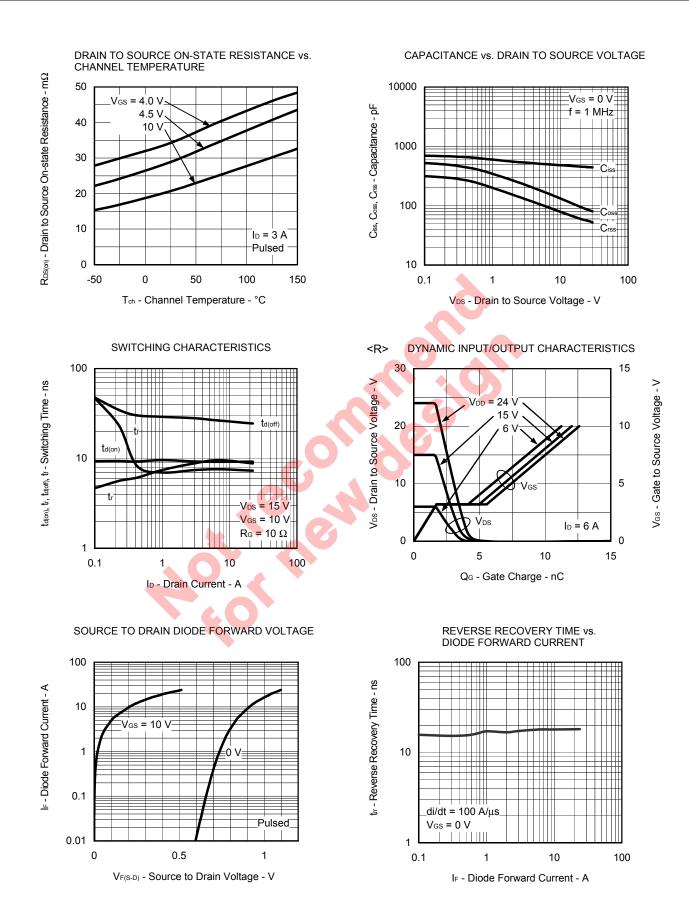


 $R_{DS(on)}$ - Drain to Source On-state Resistance - m Ω

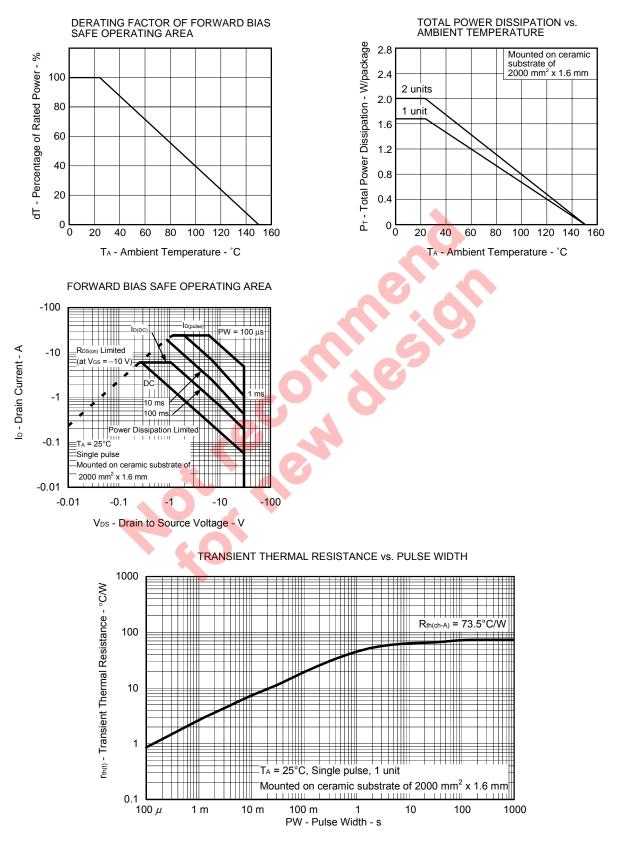


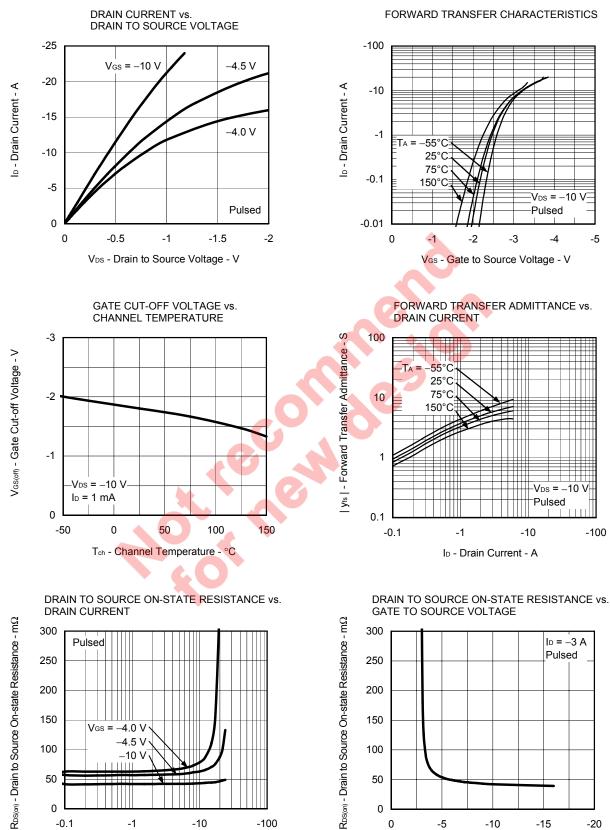
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

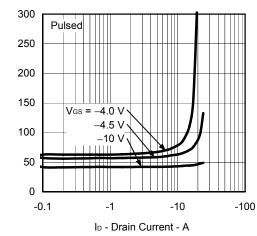


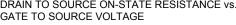


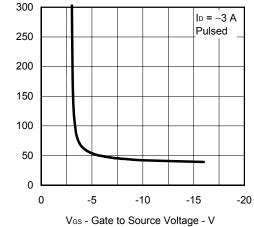
(2) P-channel

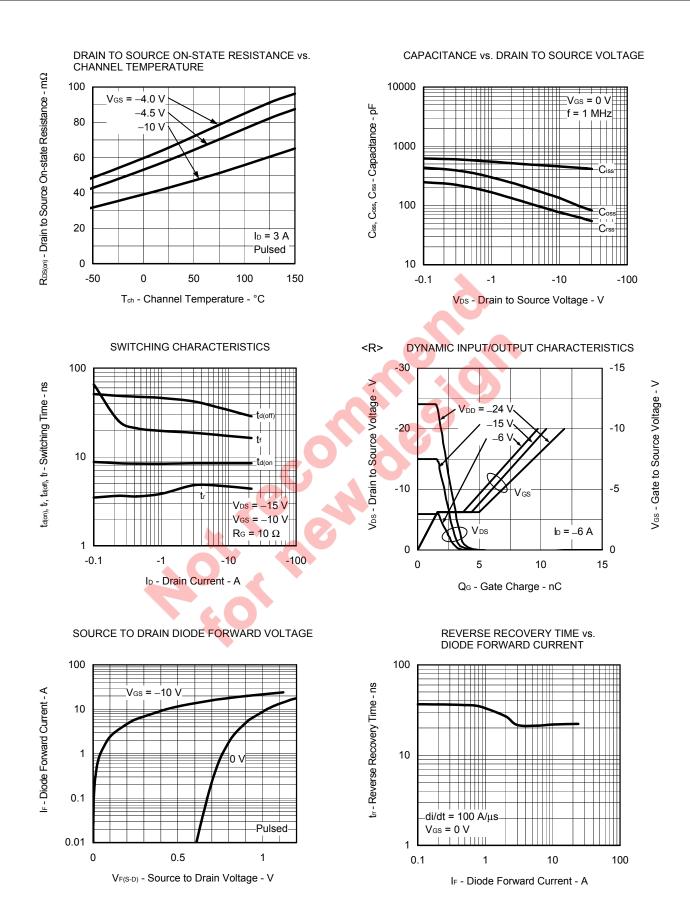












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